

Frequency Mixer

SYM-30DMHW+ SYM-30DMHW

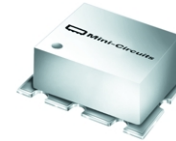
Level 13 (LO Power +13dBm) 5 to 3000 MHz

Features

- wide bandwidth, 5 to 3000 MHz
- good L-R isolation, 36 dB typ.
- excellent L-I isolation, 42 dB typ.
- triple balanced mixer

Applications

- CDMA
- GSM
- DCS
- PCN



CASE STYLE: TTT167
PRICE: \$9.95 ea. QTY (10-49)

+ RoHS compliant in accordance with EU Directive (2002/95/EC)

See our web site for RoHS Compliance methodologies and qualifications.

Mixer Electrical Specifications

MODEL NO.	FREQUENCY (MHz)		CONVERSION LOSS (dB)				LO-RF ISOLATION (dB)				LO-IF ISOLATION (dB)				IP3@ center band Typ. (dBm)	E FACTOR				
	LO/RF $f_L - f_U$	IF	Mid-Band \bar{x}	m	σ	Total Range Max.	L Typ.	M Typ.	U Typ.	L Typ.	M Typ.	U Typ.	L Typ.	M Typ.			U Typ.			
SYM-30DMHW	5-3000	5-1500	6.5	.10	8.4	9.3	36	25	39	30	34	23	41	27	42	33	45	30	22	0.9

1 dB COMP.: +9 dBm typ.
E= (IP3(dBm)-LO Power(dBm))/10
*Conversion loss increases up to 6 dB higher as IF frequency decreases from 5MHz to DC

L = low range [f_L to $10 f_L$] M = mid range [$10 f_L$ to $f_U/2$] U = upper range [$f_U/2$ to f_U]
m = mid band [$2f_L$ to $f_U/2$]

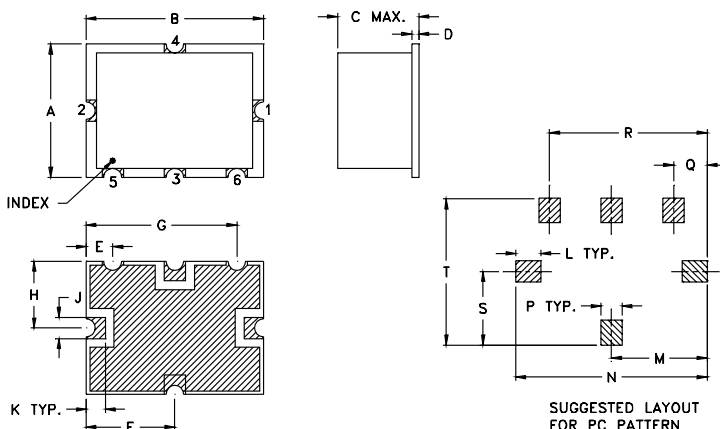
Pin Connections

LO	2
RF	1
IF	3
GROUND	4,5,6

Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	200mW
IF Current	40mA

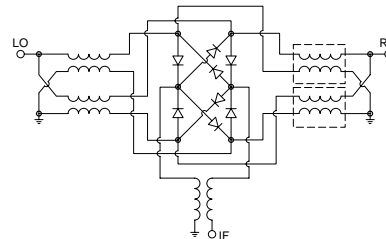
Outline Drawing



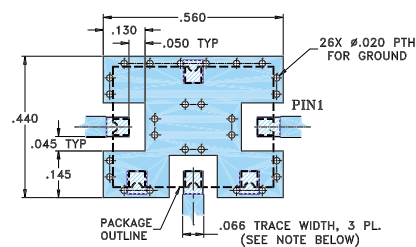
Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H	J	K	L	M	N	P	Q	R	S	T	wt.
.375	.500	.23	.020	.075	.250	.425	.187	.050	.050	.070	.270	.540	.060	.095	.445	.208	.415	grams
9.53	12.70	5.84	0.51	1.91	6.35	10.80	4.75	1.27	1.27	1.78	6.86	13.72	1.52	2.41	11.30	5.28	10.54	.8

electrical schematic



Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



- NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350 WITH DIELECTRIC THICKNESS 0.030" ± 0.002", COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. IF YOUR PCB DESIGN RULES ALLOW, GROUND VIAS SHOULD BE PLACED UNDER THE LAND PATTERN FOR BETTER RF PERFORMANCE. OTHERWISE GROUND VIAS SHOULD BE PLACED AS CLOSE TO LAND PATTERN AS POSSIBLE.
3. GROUND PAD SHALL BE FREE OF SOLDERMASK IF REQUIRED FOR SOLDERING.

■ DENOTES PCB COPPER LAYOUT
▨ DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

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Typical Performance Data

Frequency		Conversion Loss (dB)	Isolation L-R (dB)	Isolation L-I (dB)	VSWR RF port (:1)	VSWR LO port (:1)
RF MHz	LO MHz	LO +13dBm	LO +13dBm	LO +13dBm	LO +13dBm	LO +13dBm
5.10	35.11	6.58	36.03	38.39	1.15	1.57
100.10	130.11	6.50	35.88	43.47	1.08	1.55
221.15	251.16	6.49	36.20	43.04	1.13	1.54
434.31	464.32	6.56	36.53	42.16	1.25	1.53
647.47	677.48	6.43	37.23	40.16	1.44	1.52
860.63	890.64	6.59	38.94	39.55	1.66	1.49
1002.73	1032.74	6.75	40.44	39.15	1.78	1.50
1215.89	1245.90	6.44	42.67	40.10	1.88	1.46
1429.05	1459.06	6.20	42.49	40.48	1.74	1.43
1500.10	1530.11	6.25	42.48	40.72	1.68	1.42
1600.10	1630.11	6.21	41.45	40.86	1.56	1.43
1815.49	1845.50	6.39	38.09	42.04	1.39	1.39
1923.18	1953.19	6.74	35.83	42.77	1.41	1.37
2030.87	2060.88	7.04	33.82	43.36	1.49	1.35
2138.56	2168.57	7.32	31.83	43.31	1.58	1.34
2246.25	2276.26	7.45	30.59	42.74	1.58	1.28
2461.64	2491.65	7.42	29.50	42.49	1.41	1.19
2677.02	2707.03	7.35	29.11	41.54	1.11	1.12
2892.41	2922.42	7.40	29.03	38.92	1.17	1.16
3000.10	3030.11	7.48	28.88	37.68	1.28	1.17

Performance Charts

